

NL17SZ74

Single D Flip Flop

The NL17SZ74 is a high performance, full function Edge triggered D Flip Flop, with all the features of a standard logic device such as the 74LCX74.

Features

- Extremely High Speed: t_{PD} 2.6 ns (typical) at $V_{CC} = 5.0$ V
- Designed for 1.65 V to 5.5 V V_{CC} Operation
- 5.0 V Tolerant Inputs – Interface Capability with 5.0 V TTL Logic
- LVTTL Compatible
- LVCMS Compatible
- 24 mA Balanced Output Sink and Source Capability
- Near Zero Static Supply Current (10 μ A) Substantially Reduces System Power Requirements
- Replacement for NC7SZ74
- Tiny Ultra Small Package Only 2.1 X 3.0 mm
- High ESD Ratings: 2000 V Human Body Model
200 V Machine Model
- Chip Complexity: FET = 64
- NLV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant



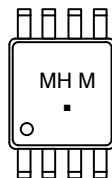
ON Semiconductor®

<http://onsemi.com>



US8
US SUFFIX
CASE 493

MARKING DIAGRAM



MH = Specific Device Code
M = Date Code
▪ = Pb-Free Package

(Note: Microdot may be in either location)

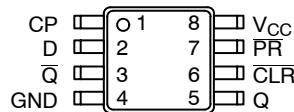
TRUTH TABLE

Inputs				Outputs		Operating Mode
PR	CLR	CP	D	Q	\bar{Q}	
L	H	X	X	H	L	Asynchronous Set
H	L	X	X	L	H	Asynchronous Clear
L	L	X	X	H	H	Undetermined
H	H	↑	h	H	L	Load and Read Register
H	H	↑	I	L	H	
						Hold

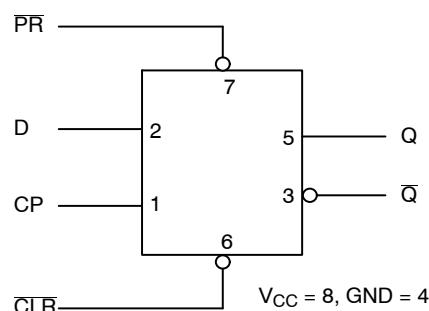
H = High Voltage Level
h = High Voltage Level One Setup Time Prior to the Low-to-High Clock Transition
L = Low Voltage Level
I = Low Voltage Level One Setup Time Prior to the Low-to-High Clock Transition
NC = No Change
X = High or Low Voltage Level and Transitions are Acceptable
↑ = Low-to-High Transition
† = Not a Low-to-High Transition

For I_{CC} reasons, DO NOT FLOAT Inputs

PINOUT DIAGRAM



LOGIC DIAGRAM



ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 3 of this data sheet.

NL17SZ74

MAXIMUM RATINGS

Symbol	Parameter	Value	Units
V_{CC}	DC Supply Voltage	-0.5 to +7.0	V
V_I	DC Input Voltage	-0.5 to +7.0	V
V_O	DC Output Voltage – Output in High or Low State (Note 1)	-0.5 to V_{CC} +0.5	V
I_{IK}	DC Input Diode Current $V_I < GND$	-50	mA
I_{OK}	DC Output Diode Current $V_O < GND$	-50	mA
I_O	DC Output Sink Current	± 50	mA
I_{CC}	DC Supply Current Per Supply Pin	± 100	mA
I_{GND}	DC Ground Current Per Ground Pin	± 100	mA
T_{STG}	Storage Temperature Range	-65 to +150	°C
T_L	Lead Temperature, 1 mm from Case for 10 Seconds	260	°C
T_J	Junction Temperature Under Bias	+150	°C
θ_{JA}	Thermal Resistance (Note 2)	250	°C/W
P_D	Power Dissipation in Still Air at 85°C	250	mW
MSL	Moisture Sensitivity	Level 1	
F_R	Flammability Rating, Oxygen Index: 28 to 34	UL 94 V-0 @ 0.125 in	
V_{ESD}	ESD Withstand Voltage Human Body Model (Note 3) Machine Model (Note 4) Charged Device Model (Note 5)	>2000 >200 N/A	V
$I_{LATCHUP}$	Latchup Performance Above V_{CC} and Below GND at 125°C (Note 6)	± 100	mA

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. I_O absolute maximum rating must be observed.
2. Measured with minimum pad spacing on an FR4 board, using 10 mm X 1 inch, 2 ounce copper trace with no air flow.
3. Tested to EIA/JESD22-A114-A.
4. Tested to EIA/JESD22-A115-A.
5. Tested to JESD22-C101-A.
6. Tested to EIA/JESD78.

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Min	Max	Units
V_{CC}	Supply Voltage Operating Data Retention Only	1.65 1.5	5.5 5.5	V
V_I	Input Voltage (Note 7)	0	5.5	V
V_O	Output Voltage (HIGH or LOW State)	0	5.5	V
T_A	Operating Free-Air Temperature	-55	+125	°C
$\Delta t/\Delta V$	Input Transition Rise or Fall Rate $V_{CC} = 2.5\text{ V} \pm 0.2\text{ V}$ $V_{CC} = 3.0\text{ V} \pm 0.3\text{ V}$ $V_{CC} = 5.0\text{ V} \pm 0.5\text{ V}$	0 0 0	20 10 5.0	ns/V

7. Unused inputs may not be left open. All inputs must be tied to a high-logic voltage level or a low-logic input voltage level.

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ORDERING INFORMATION

Device	Package	Shipping [†]
NL17SZ74USG	US8 (Pb-Free)	3000 / Tape & Reel
NLV17SZ74USG*	US8 (Pb-Free)	3000 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

*NLV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable.

DC ELECTRICAL CHARACTERISTICS

Symbol	Parameter	Condition	V _{CC} (V)	T _A = 25°C			-55°C ≤ T _A ≤ 125°C		Units
				Min	Typ	Max	Min	Max	
V _{IH}	High-Level Input Voltage		1.65	0.75 V _{CC}			0.75 V _{CC}		V
			2.3 to 5.5	0.7 V _{CC}			0.7 V _{CC}		
V _{IL}	Low-Level Input Voltage		1.65			0.25 V _{CC}		0.25 V _{CC}	V
			2.3 to 5.5			0.3 V _{CC}		0.3 V _{CC}	
V _{OH}	High-Level Output Voltage V _{IN} = V _{IL} or V _{IL}	I _{OH} = 100 µA I _{OH} = -3 mA I _{OH} = -8 mA I _{OH} = -12 mA I _{OH} = -16 mA I _{OH} = -24 mA I _{OH} = -32 mA	1.65 to 5.5	V _{CC} - 0.1	V _{CC}		V _{CC} - 0.1		V
			1.65	1.29	1.52		1.29		
			2.3	1.9	2.1		1.9		
			2.7	2.2	2.4		2.2		
			3.0	2.4	2.7		2.4		
			3.0	2.3	2.5		2.3		
			4.5	3.8	4.0		3.8		
V _{OL}	Low-Level Output Voltage V _{IN} = V _{IH}	I _{OL} = 100 µA I _{OL} = 3 mA I _{OL} = 8 mA I _{OL} = 12 mA I _{OL} = 16 mA I _{OL} = 24 mA I _{OL} = 32 mA	1.65 to 5.5		0.008	0.1		0.1	V
			1.65		0.10	0.24		0.24	
			2.3		0.12	0.3		0.3	
			2.7		0.15	0.4		0.4	
			3.0		0.19	0.4		0.4	
			3.0		0.30	0.55		0.55	
			4.5		0.30	0.55		0.55	
I _{IN}	Input Leakage Current	V _{IN} = 5.5 V or GND	0 to 5.5			±0.1		±1.0	µA
I _{OFF}	Power Off Leakage Current	V _{IN} = 5.5 V or V _{OUT} = 5.5 V	0			1.0		10	µA
I _{CC}	Quiescent Supply Current	V _{IN} = 5.5 V or GND	5.5			1.0		10	µA

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AC ELECTRICAL CHARACTERISTICS (Input $t_r = t_f = 3.0$ ns)

Symbol	Parameter	V_{CC} (V)	Test Conditions	$T_A = 25^\circ C$			$T_A = -55$ to $125^\circ C$		Units
				Min	Typ	Max	Min	Max	
f_{MAX}	Maximum Clock Frequency (50% Duty Cycle) (Waveform 1)	1.8 ± 0.15	$C_L = 15 \text{ pF}$ $R_D = 1 \text{ M}\Omega$ $S_1 = \text{Open}$	75			75		MHz
		2.5 ± 0.2		150			150		
		3.3 ± 0.3		200			200		
		5.0 ± 0.5		250			250		
		3.3 ± 0.3	$C_L = 50 \text{ pF}$, $R_D = 500 \Omega$, $S_1 = \text{Open}$	175			175		
		5.0 ± 0.5		200			200		
t_{PLH}, t_{PHL}	Propagation Delay, CP to Q or \bar{Q} (Waveform 1)	1.8 ± 0.15	$C_L = 15 \text{ pF}$ $R_D = 1 \text{ M}\Omega$ $S_1 = \text{Open}$	2.5	6.5	12.5	2.5	13	ns
		2.5 ± 0.2		1.5	3.8	7.5	1.5	8.0	
		3.3 ± 0.3		1.0	2.8	6.5	1.0	7.0	
		5.0 ± 0.5		0.8	2.2	4.5	0.8	5.0	
		3.3 ± 0.3	$C_L = 50 \text{ pF}$, $R_D = 500 \Omega$, $S_1 = \text{Open}$	1.0	3.4	7.0	1.0	7.5	
		5.0 ± 0.5		1.0	2.6	5.0	1.0	5.5	
t_{PLH}, t_{PHL}	Propagation Delay, \overline{PR} or \overline{CLR} to Q or \bar{Q} (Waveform 2)	1.8 ± 0.15	$C_L = 15 \text{ pF}$ $R_D = 1 \text{ M}\Omega$ $S_1 = \text{Open}$	2.5	6.5	14	2.5	14.5	ns
		2.5 ± 0.2		1.5	3.8	9.0	1.5	9.5	
		3.3 ± 0.3		1.0	2.8	6.5	1.0	7.0	
		5.0 ± 0.5		0.8	2.2	5.0	0.8	5.5	
		3.3 ± 0.3	$C_L = 50 \text{ pF}$, $R_D = 500 \Omega$, $S_1 = \text{Open}$	1.0	3.4	7.0	1.0	7.5	
		5.0 ± 0.5		1.0	2.6	5.0	1.0	5.5	
t_S	Setup Time, D to CP (Waveform 1)	1.8 ± 0.15	$C_L = 15 \text{ pF}$ $R_D = 1 \text{ M}\Omega$ $S_1 = \text{Open}$	6.5			6.5		ns
		2.5 ± 0.2		3.5			3.5		
		3.3 ± 0.3		2.0			2.0		
		5.0 ± 0.5		1.5			1.5		
		3.3 ± 0.3	$C_L = 50 \text{ pF}$, $R_D = 500 \Omega$, $S_1 = \text{Open}$	2.0			2.0		
		5.0 ± 0.5		1.5			1.5		
t_H	Hold Time, D to CP (Waveform 1)	1.8 ± 0.15	$C_L = 15 \text{ pF}$ $R_D = 1 \text{ M}\Omega$ $S_1 = \text{Open}$	0.5			0.5		ns
		2.5 ± 0.2		0.5			0.5		
		3.3 ± 0.3		0.5			0.5		
		5.0 ± 0.5		0.5			0.5		
		3.3 ± 0.3	$C_L = 50 \text{ pF}$, $R_D = 500 \Omega$, $S_1 = \text{Open}$	0.5			0.5		
		5.0 ± 0.5		0.5			0.5		
t_W	Pulse Width, CP, \overline{CLR} , \overline{PR} (Waveform 3)	1.8 ± 0.15	$C_L = 15 \text{ pF}$ $R_D = 1 \text{ M}\Omega$ $S_1 = \text{Open}$	6.0			6.0		ns
		2.5 ± 0.2		4.0			4.0		
		3.3 ± 0.3		3.0			3.0		
		5.0 ± 0.5		2.0			2.0		
		3.3 ± 0.3	$C_L = 50 \text{ pF}$, $R_D = 500 \Omega$, $S_1 = \text{Open}$	3.0			3.0		
		5.0 ± 0.5		2.0			2.0		
t_{REC}	Recover Time \overline{PR} ; \overline{CLR} to CP (Waveform 3)	1.8 ± 0.15	$C_L = 15 \text{ pF}$ $R_D = 1 \text{ M}\Omega$ $S_1 = \text{Open}$	8.0			8.0		MHz
		2.5 ± 0.2		4.5			4.5		
		3.3 ± 0.3		3.0			3.0		
		5.0 ± 0.5		3.0			3.0		
		3.3 ± 0.3	$C_L = 50 \text{ pF}$, $R_D = 500 \Omega$, $S_1 = \text{Open}$	3.0			3.0		
		5.0 ± 0.5		3.0			3.0		

8. C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation: $I_{CC(OPR)} = C_{PD} \cdot V_{CC} \cdot f_{in} + I_{CC}/2$ (per flip-flop). C_{PD} is used to determine the no-load dynamic power consumption; $P_D = C_{PD} \cdot V_{CC}^2 \cdot f_{in} + I_{CC} \cdot V_{CC}$.

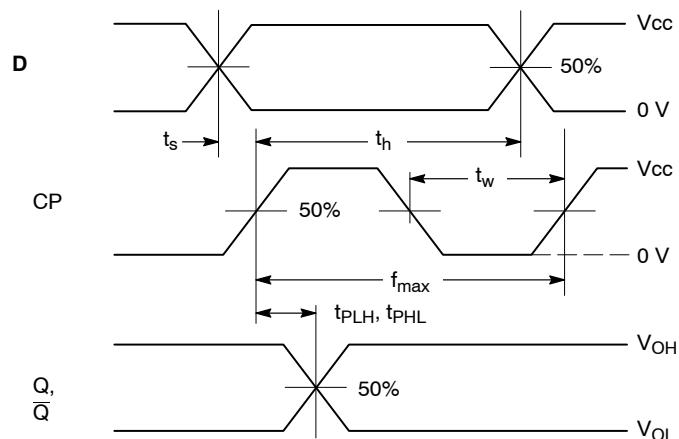
CAPACITANCE (Note 9)

Symbol	Parameter	Condition	Typical	Unit
C_{IN}	Input Capacitance	$V_{CC} = 5.5 \text{ V}$	7.0	pF
C_{OUT}	Output Capacitance	$V_{CC} = 5.5 \text{ V}$	7.0	pF
C_{PD}	Power Dissipation Capacitance (Note 10) Frequency = 10 MHz	$V_{CC} = 3.3 \text{ V}$ $V_{CC} = 5.0 \text{ V}$	16 21	pF

9. $T_A = +25^\circ C$, $f = 1 \text{ MHz}$

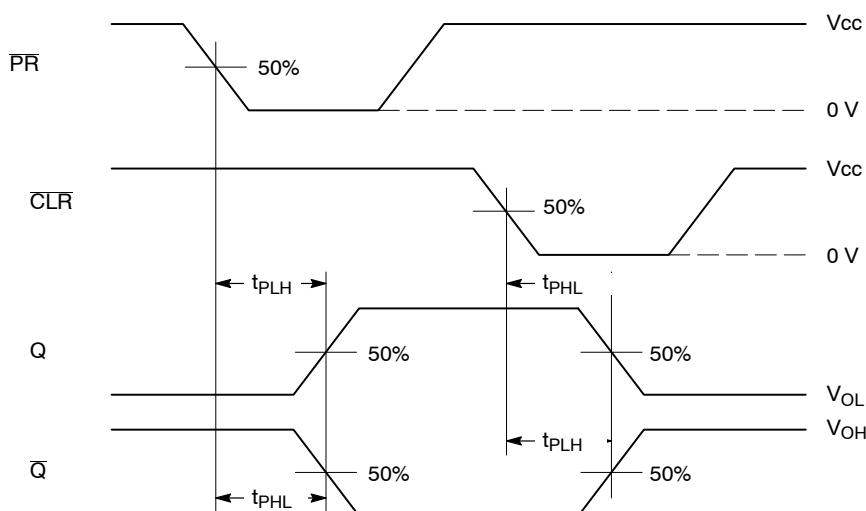
10. C_{PD} is defined as the value of the internal equivalent capacitance which is derived from dynamic operating current consumption (I_{CCD}) at no output loading and operating at 50% duty cycle. (See Figure 1) C_{PD} is related to I_{CCD} dynamic operating current by the expression: $I_{CCD} = C_{PD} \cdot V_{CC} \cdot f_{in} + I_{CC(\text{static})}$.

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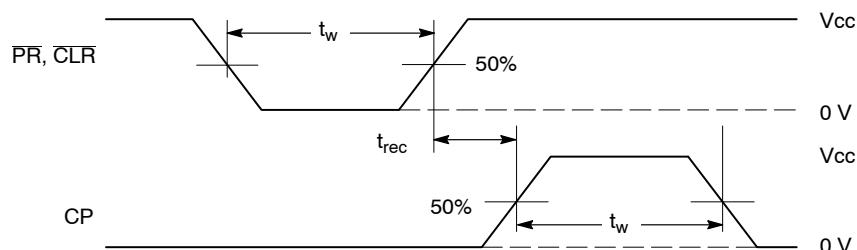
WAVEFORM 1 – PROPAGATION DELAYS, SETUP AND HOLD TIMES

$t_R = t_F = 3.0$ ns, 10% to 90%; $f = 1$ MHz; $t_W = 500$ ns



WAVEFORM 2 – PROPAGATION DELAYS

$t_R = t_F = 3.0$ ns, 10% to 90%; $f = 1$ MHz; $t_W = 500$ ns



WAVEFORM 3 – RECOVERY TIME

$t_R = t_F = 3.0$ ns from 10% to 90%; $f = 1$ MHz; $t_W = 500$ ns

Output Reg: $V_{OL} \leq 0.8$ V, $V_{OH} \geq 2.0$ V

Figure 1. AC Waveforms

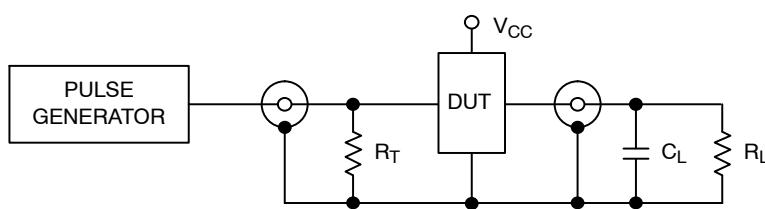
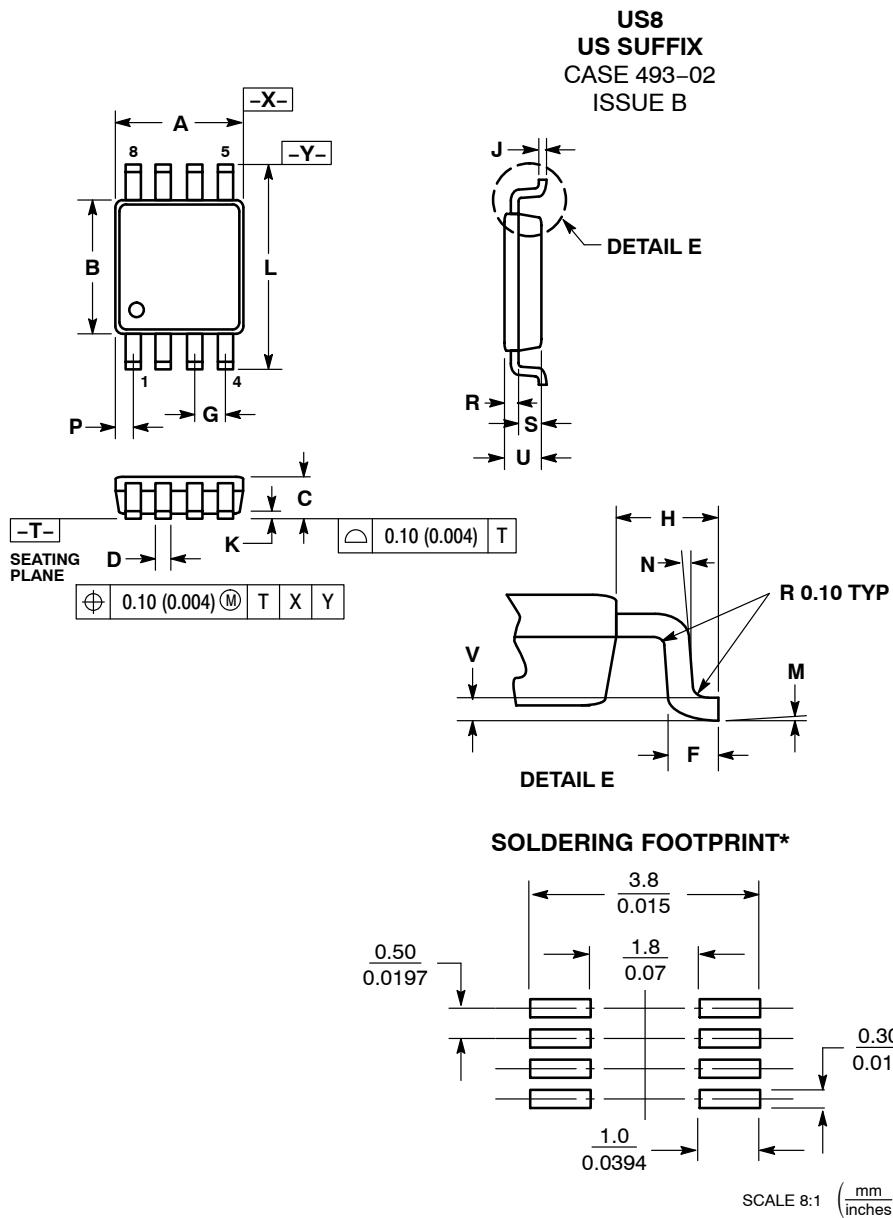


Figure 2. Test Circuit

PACKAGE DIMENSIONS



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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